



## CERAMIC BALUN

# RF Transformer

## NCS2-62+

Mini-Circuits

50Ω 390 to 590 MHz 1:2 Ratio

### FEATURES

- Low phase unbalance 5 deg. and amplitude unbalance, 0.5 dB typ.
- Miniature size 0805, 0.079"x0.049"x0.033"
- LTCC construction
- Low cost
- Aqueous washable



Generic photo used for illustration purposes only

CASE STYLE: GE0805C-9

### APPLICATIONS

- VHF/UHF
- Signal process
- Instrumentation

#### +RoHS Compliant

The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications

### ELECTRICAL SPECIFICATIONS AT 25°C

Parameter	Frequency (MHz)	Min.	Typ.	Max.	Units
Impedance Ratio (Secondary/Primary)			2		
Frequency Range		390		2815	MHz
Insertion Loss <sup>1</sup>	460 - 470	—	0.6	1.0	dB
	390 - 590	—	0.8	—	
Amplitude Unbalance	460 - 470	—	0.5	1.0	dB
	390 - 590	—	0.8	—	
Phase Unbalance <sup>2</sup>	460 - 470	—	3	8	Degree
	390 - 590	—	5	—	

1. Reference Demo Board TB-755+

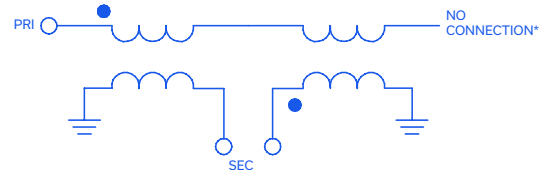
2. Relative to 180°

### MAXIMUM RATINGS

Parameter	Ratings
Operating Temperature	-55°C to 125°C
Storage Temperature	-55°C to 125°C
RF Power <sup>3</sup>	2W at 25°C

3. Passband rating, derate linearly to 1W at 125°C ambient. Permanent damage may occur if any of these limits are exceeded.

### CONFIGURATION J



\*Internal open circuit



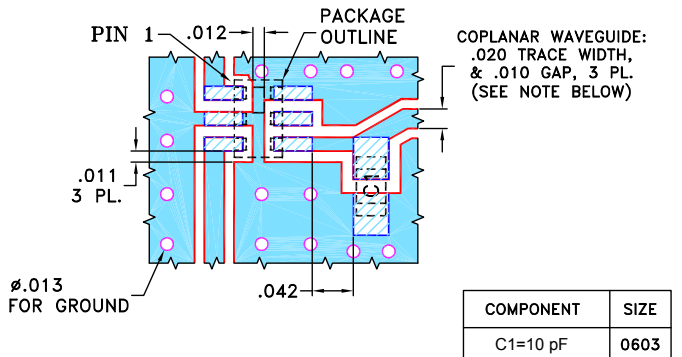


### PAD CONNECTIONS

PRIMARY DOT (Unbalanced Port)	4
PRIMARY (GND)	2,6
SECONDARY DOT (Balanced)	1
SECONDARY (Balanced)	3
NO CONNECTION	5

PRODUCT MARKING: N/A

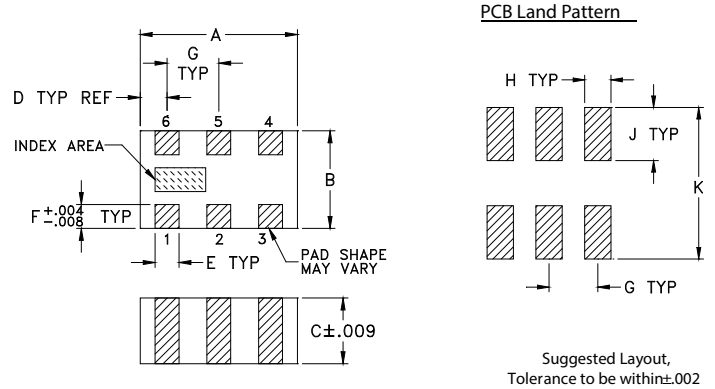
### DEMO BOARD MCL P/N: TB-755+ SUGGESTED PCB LAYOUT (PL-438)



- NOTES:**
1. COPLANAR WAVEGUIDE IS SHOWN FOR ROGERS R04350B WITH THICKNESS .010" ± .001". COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH & GAP MAY NEED TO BE MODIFIED.
  2. CHIP COMPONENT FOOT PRINTS SHOWN FOR REFERENCE. FOR COMPONENT VALUES REFER TO TB-755+.
  3. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

- DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)
- DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

### OUTLINE DRAWING



### OUTLINE DIMENSIONS (Inches/mm)

A	B	C	D	E	F
.079	.049	.033	.014	.012	.012
2.0	1.24	0.84	0.36	0.30	0.30
G	H	J	K	wt	
.026	.014	.039	.110	grams	
0.66	0.36	1.00	2.80	.008	

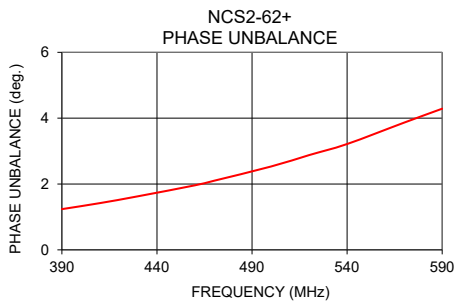
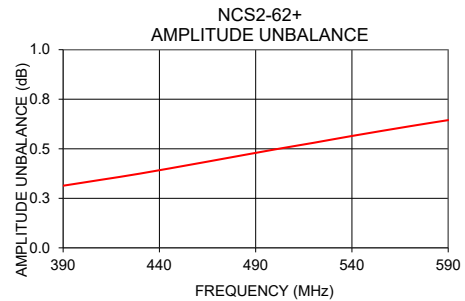
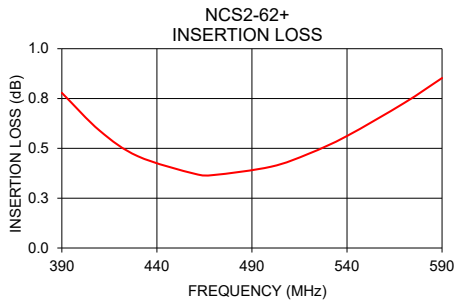
### TAPE & REEL INFORMATION: F74



### TYPICAL PERFORMANCE DATA<sup>3</sup>

Frequency (MHz)	Insertion Loss (dB)	Input Return Loss (dB)	Amplitude Unbalance (dB)	Phase Unbalance (deg)
390	0.78	10.62	0.31	1.24
410	0.59	12.87	0.34	1.42
430	0.46	15.47	0.37	1.63
460	0.37	18.26	0.43	1.96
470	0.37	17.45	0.46	2.10
500	0.41	15.45	0.50	2.53
520	0.47	13.50	0.53	2.88
540	0.56	11.90	0.56	3.22
570	0.73	10.04	0.61	3.87
590	0.85	9.09	0.64	4.29

3. Measured with Agilent E5071B network analyzer using impedance conversion and port extension.



#### NOTES

- A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
- B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
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# RF Transformer

# NCS2-62+

## Typical Performance Data

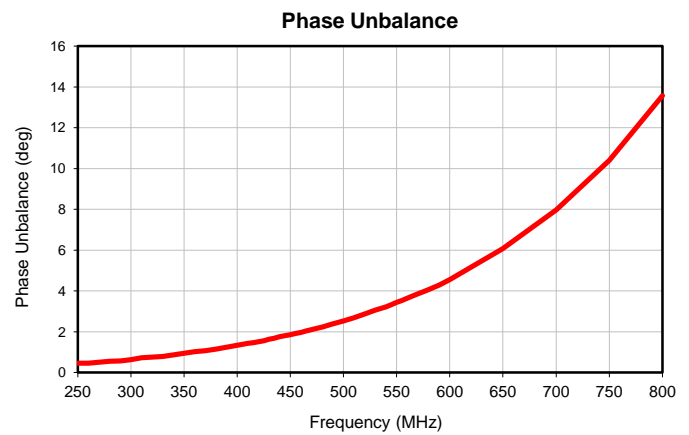
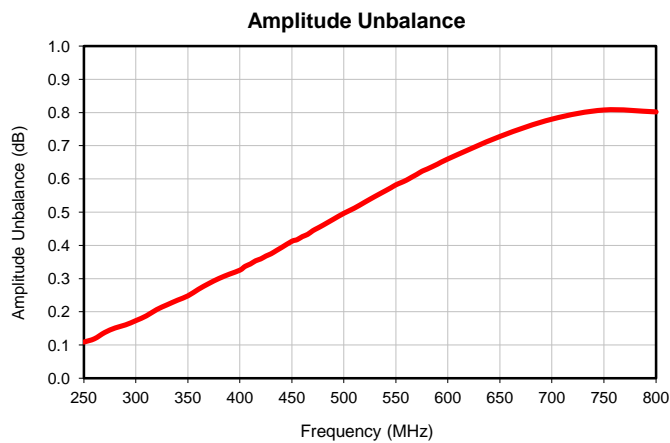
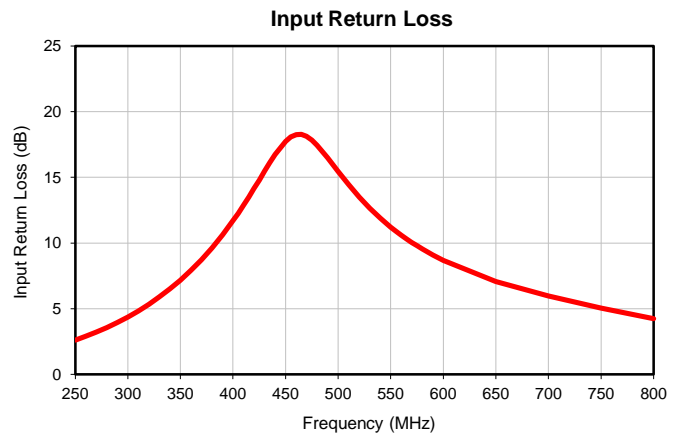
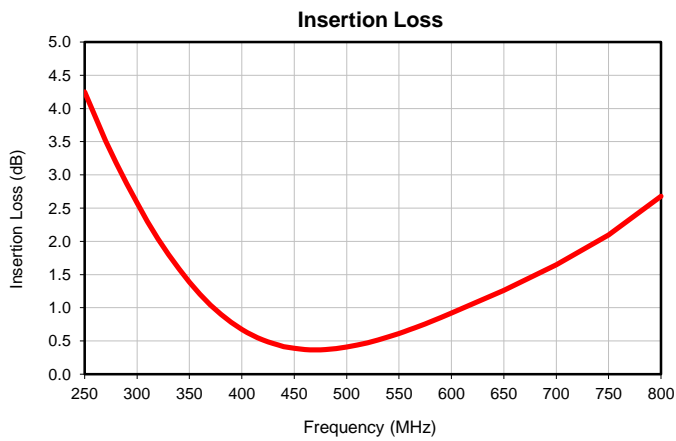
FREQUENCY MHz	INSERTION LOSS* (dB)	INPUT RETURN LOSS (dB)	AMPLITUDE UNBALANCE (dB)	PHASE UNBALANCE** (deg.)
250	4.25	2.61	0.11	0.45
260	3.88	2.90	0.12	0.46
270	3.52	3.21	0.14	0.50
280	3.18	3.56	0.15	0.55
290	2.87	3.94	0.16	0.56
300	2.58	4.36	0.17	0.62
310	2.30	4.82	0.19	0.72
320	2.04	5.33	0.21	0.75
330	1.80	5.89	0.22	0.78
340	1.58	6.50	0.24	0.86
350	1.39	7.17	0.25	0.94
360	1.20	7.91	0.27	1.01
370	1.04	8.73	0.29	1.07
380	0.90	9.62	0.30	1.15
390	0.78	10.62	0.31	1.24
400	0.67	11.69	0.33	1.33
405	0.63	12.27	0.34	1.39
410	0.59	12.87	0.34	1.42
415	0.55	13.50	0.35	1.45
420	0.52	14.15	0.36	1.51
425	0.49	14.80	0.37	1.56
430	0.46	15.47	0.37	1.63
435	0.44	16.12	0.38	1.68
440	0.42	16.73	0.39	1.76
450	0.39	17.74	0.41	1.86
455	0.38	18.08	0.42	1.91
460	0.37	18.26	0.43	1.96
465	0.37	18.28	0.43	2.03
470	0.37	18.13	0.44	2.10
475	0.37	17.84	0.45	2.16
480	0.37	17.45	0.46	2.24
490	0.38	16.49	0.48	2.38
500	0.41	15.45	0.50	2.53
510	0.44	14.44	0.51	2.69
520	0.47	13.50	0.53	2.88
530	0.51	12.65	0.55	3.05
540	0.56	11.90	0.56	3.22
545	0.59	11.54	0.57	3.33
550	0.61	11.21	0.58	3.44
555	0.64	10.89	0.59	3.54
560	0.67	10.59	0.60	3.64
565	0.70	10.31	0.61	3.74
570	0.73	10.04	0.61	3.87
575	0.76	9.79	0.62	3.95
580	0.79	9.54	0.63	4.07
590	0.85	9.09	0.64	4.29
600	0.92	8.68	0.66	4.55
650	1.26	7.08	0.73	6.07
700	1.65	5.96	0.78	7.97
750	2.10	5.05	0.81	10.40
800	2.68	4.24	0.80	13.56

\* Reference Demo Board TB-755+

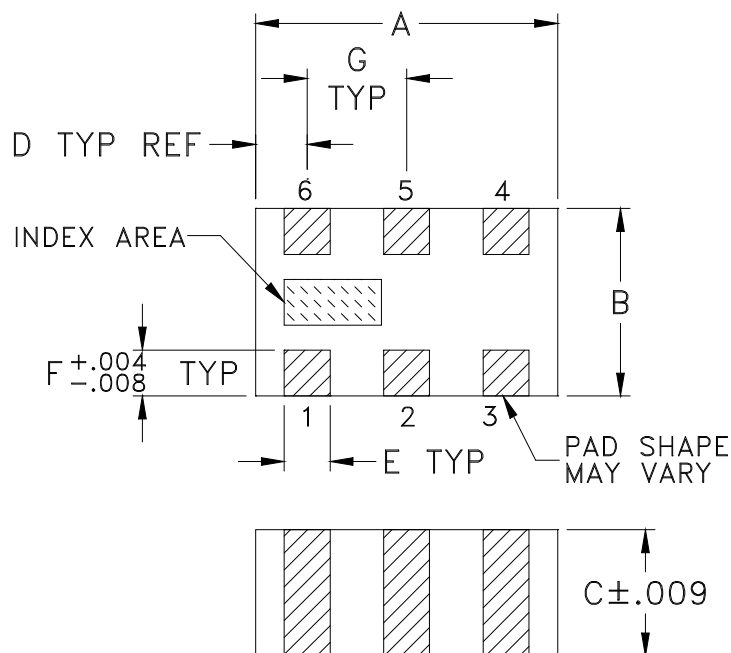
\*\*Phase Unbalance is relative to 180°



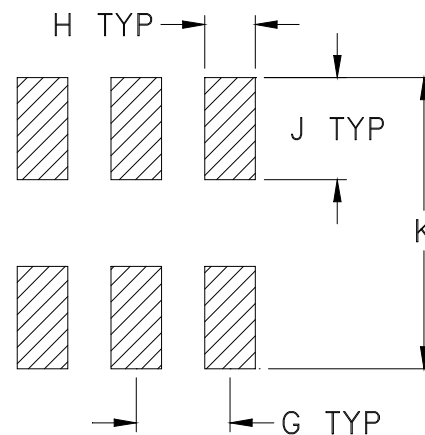
## Typical Performance Data



### Outline Dimensions



### PCB Land Pattern



Suggested Layout,  
Tolerance to be within  $\pm .002$

CASE #	A	B	C	D	E	F	G	H	J	K	WT.GRAM
GE0805C-9	.079 (2.00)	.049 (1.25)	.037 (0.95)	.014 (0.35)	.012 (0.30)	.012 (0.30)	.026 (0.65)	.014 (0.35)	.039 (1.00)	.110 (2.80)	.008

Dimensions are in inches (mm). Tolerances: 2Pl.  $\pm .01$ ; 3 Pl.  $\pm .005$

#### Notes:

- Open style, ceramic base.
- Termination finish: For RoHS Case Styles: Tin plate over Nickel plate. All models, (+) suffix.  
For RoHS-5 Case Styles: Tin-Lead plate over Nickel plate. All models, no (+) suffix.



P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661 For detailed performance specs & shopping online see Mini-Circuits web site



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RF/IF MICROWAVE COMPONENTS

# Tape & Reel Packaging TR-F114

## DEVICE ORIENTATION IN T&R

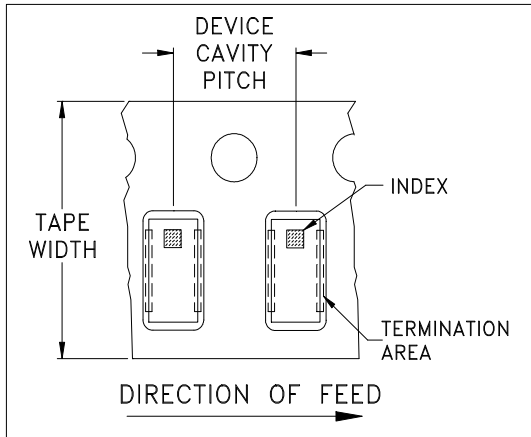


ILLUSTRATION 1

Applicable Case Styles	
GE0805C	JC0603C
GE0805C-1	JC0603C-4
GE0805C-1AP	JC0603C-6
GE0805C-7	
GE0805C-9	
GE0805C-10	
GE0805C-11	
GE0805C-12	

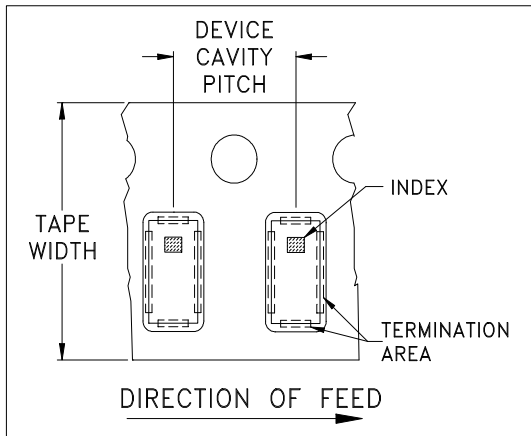


ILLUSTRATION 2

Applicable Case Styles	
GE0805C-2	JC0603C-1
GE0805C-3	JC0603C-2
GE0805C-4	JC0603C-3
GE0805C-5	JC0603C-5
GE0805C-6	JC0603C-7
GE0805C-8	JV1210C-1
GE0805C-15	

Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel	
8	4	7	Small quantity standards (see note)	20
				50
				100
				200
				500
				1000
			Standard	4000

Note: Please Consult individual model data sheet to determine device per reel availability.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

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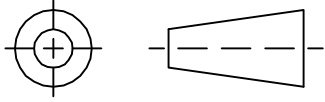
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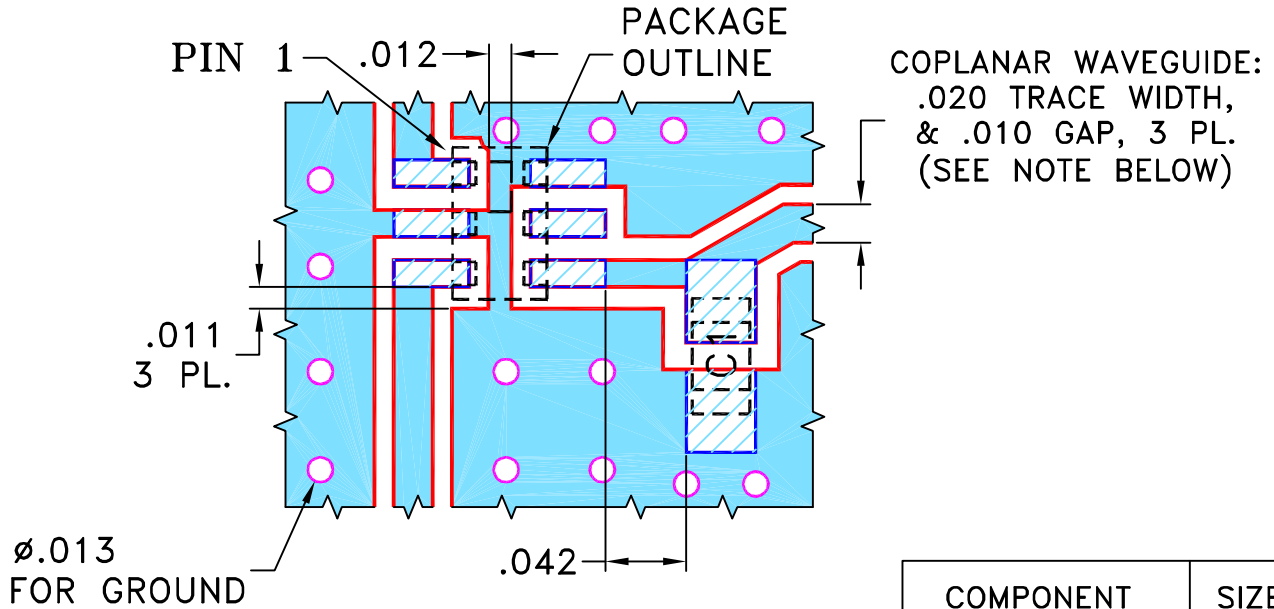
THIRD ANGLE PROJECTION



REVISIONS

REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
OR	M148470	NEW RELEASE	10/03/14	GF	MY

**SUGGESTED MOUNTING CONFIGURATION  
FOR GE0805C-9 CASE STYLE, "06TJ04" PIN CONNECTION**



COMPONENT	SIZE
C1	0603

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  3. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.



DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)



DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

UNLESS OTHERWISE SPECIFIED	INITIALS	DATE
DRAWN	GF	10/02/14
CHECKED	IL	10/03/14
APPROVED	MY	10/03/14

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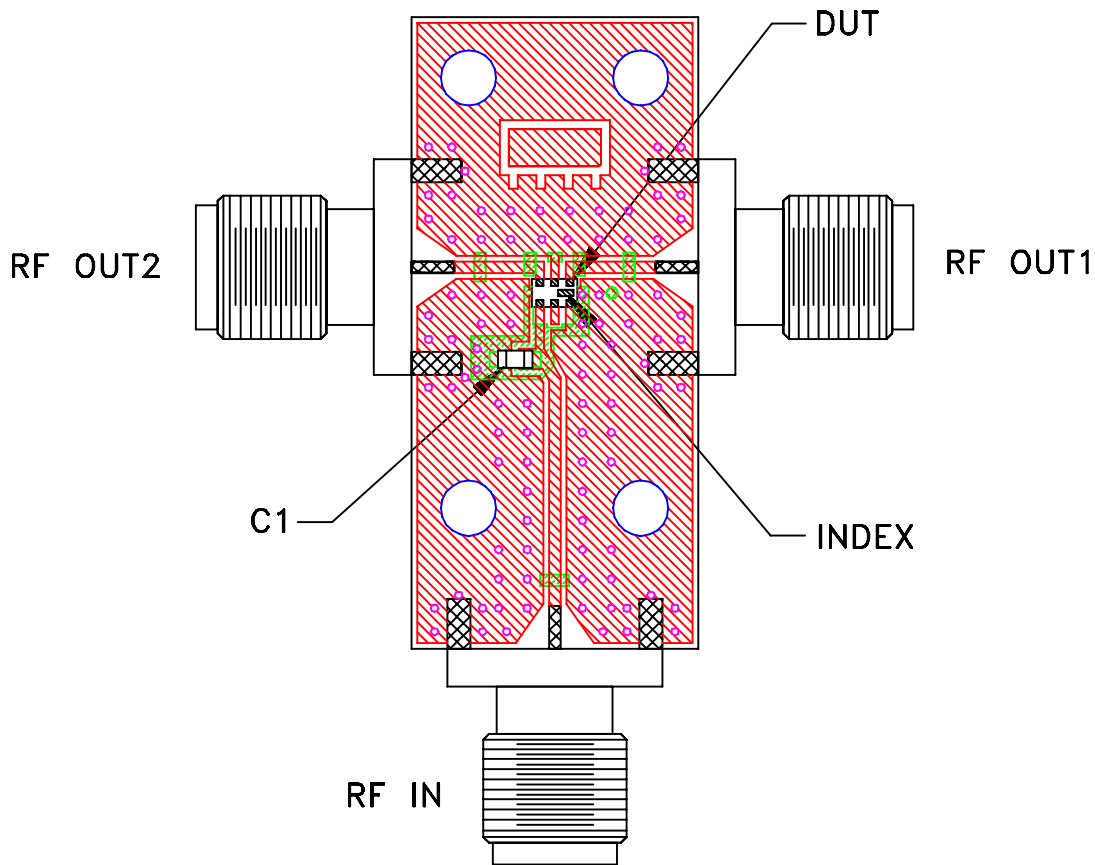
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PL, 06TJ04, GE0805C-9, TB-755+

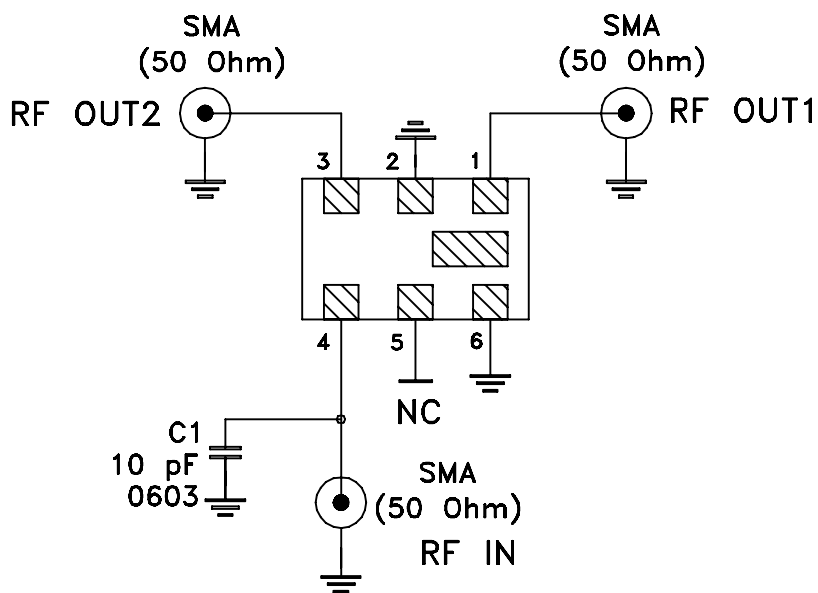
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FILE:	98PL438	SCALE:	10:1
SHEET:	1	OF	1



# Evaluation Board and Circuit



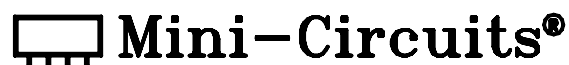
TB-755+



Schematic Diagram

**Notes:**

1. 50 Ohm SMA Female connectors.
2. PCB Material: R04350 or equivalent,  
Dielectric Constant=3.5, Thickness=.010 inch.





All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-55° to 100°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, Para 4.2.5, Test S, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A